

DATASHEET

FEATURES:

- Multi-Source Package with Duplex LC Connector
- Up to 622Mb/s Data Links
- Single +3.3V Power Supply
- Hot-Pluggable
- Compliant with Bellcore TA-NWT-000983
- Compliant with Specifications for IEEE802.3Z
- Eye Safety Designed to Meet Laser Class1, Compliant with IEC60825
- Monitoring Interface Compliant with SFF-8472, Real time monitoring of:
 - Transmitter optical power
 - Receiver optical power
 - Laser bias current
 - Temperature
 - Supply voltage
- RoHS Compliant Products

APPLICATIONS:

- SONET/SDH System
 - ATM
- Other Optical Links

SPECIFICATIONS:

Electrical and Optical Characteristics: (Condition: T_c=T_{OP})

Parameter	Symbol	Min.	Typical	Max.	Unit
Transmitter Differential Input Volt	+/-TX_DAT	200		2400	mV p-p
Supply Current	I _{CC}		130	180	mA
Tx_Disable Input Voltage — Low	V_{IL}	0		0.8	V
Tx_Disable Input Voltage - High	V_{IH}	2.0		Vcc	V
Tx_Fault Output Voltage – Low	V_{OL}	0		0.8	V
Tx_Fault Output Voltage — High	V_{OH}	2.0		Vcc	٧
Receiver Differential Output Volt	+/-RX_DAT	600		1400	mV p-p
Rx_LOS Output Voltage- Low	V_{OL}	0		0.8	V
Rx_LOS Output Voltage- High	V_{OH}	2.0		Vcc	V



Transmitter:

Parameter	Symbol	Min.	Typical	Max.	Unit
Data Rate	В	-	622	-	Mb/s
Output Center Wavelength	λ_{C}	1480	1550	1580	nm
Output Spectral Width9-20dB)	Δλ	-	-	1	nm
Average Output Power	Po	-3		+2	dBm
Extinction Ratio	E.R.	10	-	-	dB
Data Input Voltage-High	V_{IHS}	V _{cc} -1.16	-	V _{cc} -0.89	V
Data Input Voltage -Low	V_{ILS}	V _{cc} -1.82	-	V _{cc} -1.48	V
Supply Current	I_{CC}	-	90	130	mA
Output Optical Eye	Compliant with ITU-T G.957				

Receiver:

Parameter	Symbol	Min.	Typical	Max.	Unit
Receive Sensitivity	P _{min}	-	-	-28	dBm
Maximum Input Power	P _{MAX}	-3	-	-	dBm
RX_LOS Assert Level	S _D	-40	-	-	dBm
RX_LOS De Assert Level	S _A	-	-	-30	dBm
Operating Wavelength	λς	1100	-	1600	nm
Supply Current	I _{CC}	-	80	110	mA

Absolute Maximum Ratings: (T_c=25°)

Parameter	Symbol	Min.	Max.	Unit
Storage Temperature	T _{ST}	-40	+85	°C
Operating Temperature	T_{IP}	0	+70	°C
Input Voltage	T _{CC}	0	+5	V



Recommended Operating Environment:

Parameter	Symbol	Min.	Typical	Max.	Unit
Supply Voltage	V _{CC}	+3.0	+3.3	+3.6	V
Operating Temperature	T _{OP}	0	-	+70	°C

Timing Characteristics:

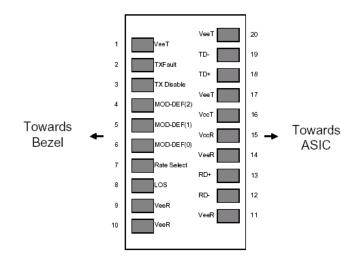
Parameter	Symbol	Min.	Typical	Max.	Unit
TX_DISABLE Assert Time	t_off		3	10	usec
TX_DISABLE Negate Time	t_on		0.5	1	msec
Time to Initialize Include Reset of TX_FAULT	t_int		30	300	msec
TX_FAULT from Fault to Assertion	t_fault		20	100	usec
TX_DISBEL Time to Start Reset	t_reset	10			usec
Receiver Loss of Signal Assert Time (Off to On)	T _A ,RX_LOS			100	usec
Receiver Loss of Signal Assert Time (On to Off)	T _d ,RX_LOS			100	usec

Digital Diagnostic Monitor Characteristics:

Parameter.	Min.	Unit
Tx Output Power Accuracy	±3.0	dBm
Rx Input Power Accuracy	±3.0	dBm
Laser Bias Current Accuracy	±1 0	%
Transceiver Internal Temperature Accuracy	±3.0	°C
Transceiver Internal Supply Voltage Accuracy	±0.1	V



Pin Assignment:



Pin out of Connector Block on Host Board

Pin Description:

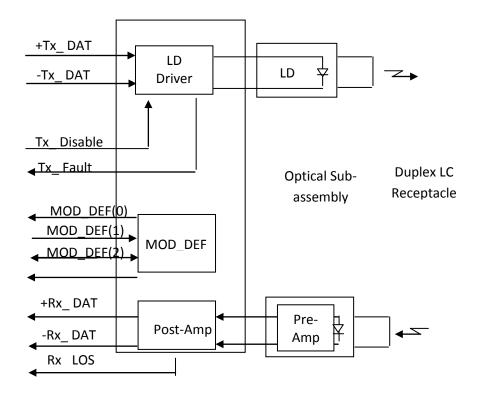
Pin	Symbol	Name/Description	Ref.
1	V _{EET}	Transmitter Ground (Common with Receiver Ground)	1
2	T _{FAULT}	Transmitter Fault. Low normal operation, High Fault indication	-
3	T _{DIS}	Transmitter Disable. Laser output disabled on high or open.	2
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	3
5	MOD DEF(1)	Module Definition 1. Clock line for Serial ID.	3
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	3
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation.	4
9	V_{EER}		
10	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
11	V _{EER}	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out. AC Coupled	
13	RD+	Receiver Non-inverted DATA out. AC Coupled	
14	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
15	V_{CCR}	Receiver Power Supply	
16	V _{CCT}	Transmitter Power Supply	
17	V _{EET} Transmitter Ground (Common with Receiver Ground)		1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	V _{EET}	Transmitter Ground (Common with Receiver Ground)	1

Notes:

- 1. Circuit ground is internally isolated from chassis ground.
- 2. Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
- Should be pulled up with 4.7k 10kohms on host board to a voltage between 2.0V and 3.6V. MOD_DEF(0) pulls line low to indicate module is plugged in.
- 4. LOS is open collector output. Should be pulled up with 4.7k 10kohms on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.



Block Diagram of Transceiver:





Serial ID Memory Contents:

Data	Length	Name of	
Address	(Byte)	Length	Description and Contents
Base ID Fields	5		
0	1	Identifier	Type of Serial transceiver (03h=SFP)
1	1	Reserved	Extended identifier of type serial transceiver (04h)
2	1	Connector	Code of optical connector type (07=LC)
3-10	8	Transceiver	SONET
11	1	Encoding	NRZ (03h)
12	1	BR,Nominal	Nominal baud rate, unit of 100Mbps
13-14	2	Reserved	(0000h)
15	1	Length(9um)	Link length supported for 9/125um fiber, units of 100m
16	1	Length(50um)	Link length supported for 50/125um fiber, units of 10m
17	1	Length(62.5um)	Link length supported for 62.5/125um fiber, units of 10m
18	1	Length(Copper)	Link length supported for copper, units of meters
19	1	Reserved	
20-35	16	Vendor Name	SFP vendor name: PeakOptical®
36	1	Reserved	
37-39	3	Vendor OUI	SFP transceiver vendor OUI ID
40-55	16	Vendor PN	Part Number: "PSFP-xxxxxx" (ASCII)
56-59	4	Vendor rev	Revision level for part number
60-62	3	Reserved	
63	1	CCID	Least significant byte of sum of data in address 0-62
Extended ID F	ields		
64-65	2	Option	Indicates which optical SFP signals are implemented
			(001Ah = LOS, TX_FAULT, TX_DISABLE all supported)
66	1	BR, max	Upper bit rate margin, units of %
67	1	BR, min	Lower bit rate margin, units of %
68-83	16	Vendor SN	Serial number (ASCII)
84-91	8	Date code	PeakOptical®'s Manufacturing date code
92-94	3	Reserved	
95	1	CCEX	Check code for the extended ID Fields (addresses 64 to 94)
Vendor Specif	ic ID Fields	1	
96-127	32	Readable	PeakOptical® specific date, read only



Serial ID Memory Contents: (A2H)

Address	# Bytes	Name	Description
00-01	2	Temp High Alarm	MSB at low address
02-03	2	Temp Low Alarm	MSB at low address
04-05	2	Temp High Warning	MSB at low address
06-07	2	Temp Low Warning	MSB at low address
08-09	2	Voltage High Alarm	MSB at low address
10-11	2	Voltage Low Alarm	MSB at low address
12-13	2	Voltage High Warning	MSB at low address
14-15	2	Voltage Low Warning	MSB at low address
16-17	2	Bias High Alarm	MSB at low address
18-19	2	Bias Low Alarm	MSB at low address
20-21	2	Bias High Warning	MSB at low address
22-23	2	Bias Low Warning	MSB at low address
24-25	2	TX Power High Alarm	MSB at low address
26-27	2	TX Power Low Alarm	MSB at low address
28-29	2	TX Power High Warning	MSB at low address
30-31	2	TX Power Low Warning	MSB at low address
32-33	2	RX Power High Alarm	MSB at low address
34-35	2	RX Power Low Alarm	MSB at low address
36-37	2	RX Power High Warning	MSB at low address
38-39	2	RX Power Low Warning	MSB at low address
40-55	16	Reserved	Reserved for future monitored quantities



Address	# Bytes	Name	Description
56.50		D DIA(D(4)	Single precision floating point calibration data - Rx optical power.
56-59	4	Rx_PWR(4)	Bit 7 of byte 56 is MSB. Bit 0 of byte 59 is LSB.
60.63	4	Dv. DWD(2)	Single precision floating point calibration data - Rx optical power.
60-63	4	Rx_PWR(3)	Bit 7 of byte 60 is MSB. Bit 0 of byte 63 is LSB.
64-67	4	Dv. DWD/2)	Single precision floating point calibration data - Rx optical power.
04-07	4	Rx_PWR(2)	Bit 7 of byte 64 is MSB, bit 0 of byte 67 is LSB.
68-71	4	Dv. DWD/1)	Single precision floating point calibration data - Rx optical power.
00-71	4	Rx_PWR(1)	Bit 7 of byte 68 is MSB, bit 0 of byte 71 is LSB.
72-75	4	Rx_PWR(0)	Single precision floating point calibration data - Rx optical power.
72-75	4	KX_PVVK(U)	Bit 7 of byte 72 is MSB, bit 0 of byte 75 is LSB.
76-77	2	Ty I/Clana)	Fixed decimal (unsigned) calibration data, laser bias current.
70-77	2	Tx_I(Slope)	Bit 7 of byte 76 is MSB, bit 0 of byte 77 is LSB.
			Fixed decimal (signed two's complement) calibration data,
78-79	2	Tx_I(Offset)	laser bias current.
			Bit 7 of byte 78 is MSB, bit 0 of byte 79 is LSB
			Fixed decimal (unsigned) calibration data,
80-81	2	Tx_PWR(Slope)	transmittercoupled output power.
			Bit 7 of byte 80 is MSB, bit 0 of byte81 is LSB.
			Fixed decimal (signed two's complement) calibration data,
82-83	2	Tx_PWR(Offset)	transmitter coupled output power.
			Bit 7 of byte 82 is MSB, bit 0 of byte 83 is LSB.
			Fixed decimal (unsigned) calibration data,
84-85	2	T(Slope)	internal module temperature.
			Bit 7 of byte 84 is MSB, bit 0 of byte 85 is LSB.
			Fixed decimal (signed two's complement) calibration data,
86-87	2	T(Offset)	internal module temperature.
			Bit 7 of byte 86 is MSB, bit 0 of byte 87 is LSB.
			Fixed decimal (unsigned) calibration data,
88-89	2	V(Slope)	internal module supply voltage.
			Bit 7 of byte 88 is MSB, bit 0 of byte 89 is LSB.
			Fixed decimal (signed two's complement) calibration data,
90-91	2	V(Offset)	internal module supply voltage.
			Bit 7 of byte 90 is MSB. Bit 0 of byte 91 is LSB.
92-95	4	Reserved	Reserved



Byte	Bit	Name	Description
Conver	ted ar	nalog values. Calibrated 16 bit d	lata
96	All	Temperature MSB	Internally measured module temperature.
97	All	Temperature LSB	
98	All	Vcc MSB	Internally measured supply voltage in transceiver.
99	All	Vcc LSB	
100	All	TX Bias MSB	Internally measured TX Bias Current.
101	All	TX Bias LSB	
102	All	TX Power MSB	Measured TX output power.
103	All	TX Power LSB	
104	All	RX Power MSB	Measured RX input power.
105	All	RX Power LSB	
106	All	Reserved MSB	Reserved for 1st future definition of digitized analog input
107	All	Reserved LSB	Reserved for 1st future definition of digitized analog input
108	All	Reserved MSB	Reserved for 2nd future definition of digitized analog input
109	All	Reserved LSB	Reserved for 2nd future definition of digitized analog input
Option	al Sta	tus/Control Bits	
110	7	TX Disable State	Digital state of the TX Disable Input Pin. Not supported.
110	6	Soft TX Disable	Read/write bit that allows software disable of laser.
110	0	SUIT IX DISABLE	Not supported.
110	5	Reserved	
110	4	RX Rate Select State	Digital state of the SFP RX Rate Select Input Pin.
110		NA Nate Select State	Not supported.
110	3	Soft RX Rate Select	Read/write bit that allows software RX rate select.
			Not supported.
110	2	TX Fault	Digital state of the TX Fault Output Pin.
110	1	LOS	Digital state of the LOS Output Pin.
110	0	Data Ready	Indicates transceiver has achieved power up and data is ready
111	7-0	Reserved	Reserved.

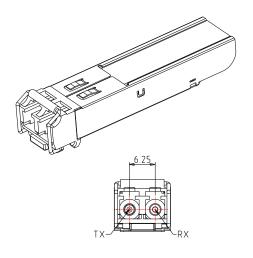


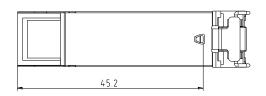
Byte	Bit	Name	Description				
Reserved Optional Alarm and Warning Flag Bits							
112	7	Temp High Alarm	Set when internal temperature exceeds high alarm level.				
112	6	Temp Low Alarm	Set when internal temperature is below low alarm level.				
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.				
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.				
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.				
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.				
112	1	TX Power High Alarm	Set when TX output power exceeds high alarm level.				
112	0	TX Power Low Alarm	Set when TX output power is below low alarm level.				
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.				
113	6	RX Power Low Alarm	Set when Received Power is below low alarm level.				
113	5	Reserved Alarm					
113	4	Reserved Alarm					
113	3	Reserved Alarm					
113	2	Reserved Alarm					
113	1	Reserved Alarm					
113	0	Reserved Alarm					
114	All	Reserved					
115	All	Reserved					
116	7	Temp High Warning	Set when internal temperature exceeds high warning level.				
116	6	Temp Low Warning	Set when internal temperature is below low warning level.				
116	5	Vcc High Warning	Set when internal supply voltage exceeds high warning level.				
116	4	Vcc Low Warning	Set when internal supply voltage is below low warning level.				
116	3	TX Bias High Warning	Set when TX Bias current exceeds high warning level.				
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.				
116	1	TX Power High Warning	Set when TX output power exceeds high warning level.				
116	0	TX Power Low Warning	Set when TX output power is below low warning level.				
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.				
117	6	RX Power Low Warning	Set when Received Power is below low warning level.				
117	5	Reserved Warning					
117	4	Reserved Warning					
117	3	Reserved Warning					
117	2	Reserved Warning					
117	1	Reserved Warning					
117	0	Reserved Warning					
118	All	Reserved					
119	All	Reserved					

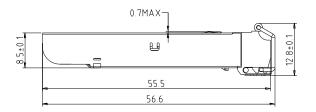


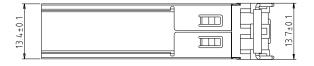
Byte	# Byte	Name	Description
120-127	8	Vendor Specific	00h.
128-255	128		Writable Memory

Mechanical Dimensions:

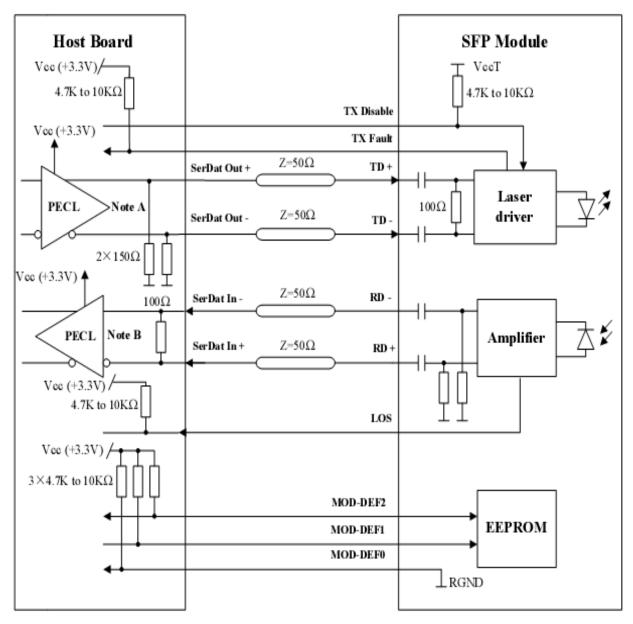








Recommended Circuit:



Note A: Circuit assumes open emitter output

Note B: Circuit assumes high impedance internal bias @Vcc-1.3V